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| MC144032B6WCB-SP | TLY 144 x 3 | 2 LCD Module     |
|------------------|-------------|------------------|
|                  |             | Specification    |
| Version:         | 1           | Date: 29/08/2011 |
|                  |             | Revision         |
| 1                | 29/08/2011  | First Issue      |

| Display F             | eatures                 |                     |                  |
|-----------------------|-------------------------|---------------------|------------------|
| Resolution            | 144 x 32                |                     |                  |
| Appearance            | Black on Yellow/Green   |                     |                  |
| Logic Voltage         | 5V                      |                     | 1                |
| Interface             | Parallel                |                     | CHS              |
| Font Set              | English/Chinese Big 5   | \ \ \ CC            | NOHS<br>ompliant |
| Display Mode          | Transflective           |                     | mphant           |
| LC Type               | STN                     |                     |                  |
| Module Size           | 80.00 x 36.00 x 13.20mm |                     |                  |
| Operating Temperature | -20°C ~ +70°C           |                     |                  |
| Construction          | COB                     | <b>Box Quantity</b> | Weight / Display |
| LED Backlight         | Yellow/Green            |                     |                  |

\* - For full design functionality, please use this specification in conjunction with the ST7920 specification. (Provided Separately)

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## **General Specification**

The Features is described as follow:

■ Module dimension: 80.0 x36.0 x 13.2 (max.) mm<sup>3</sup>

■ View area: 66.0 x 16.0 mm<sup>2</sup>

Active area: 60.44x 13.4 mm<sup>2</sup>

■ Number of Dots: 144x 32

■ Dot size: 0.38 x 0.38 mm<sup>2</sup>

■ Dot pitch: 0.42 x 0.42mm<sup>2</sup>

■ LCD type: STN Positive, Yellow Green Transflective

■ Duty: 1/32

■ View direction: 6 o'clock

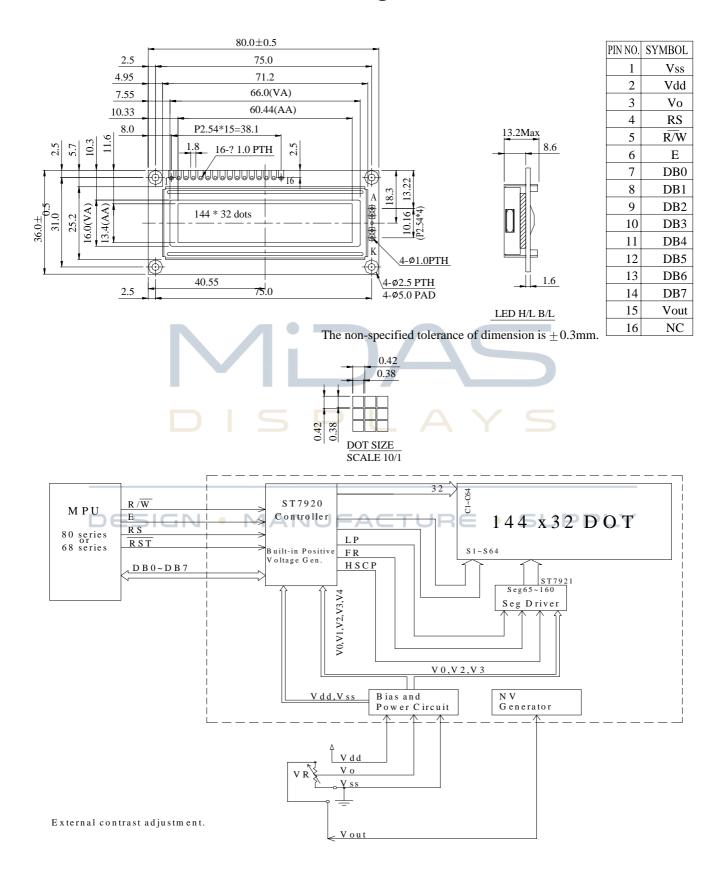
■ Backlight Type: LED yellow green

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## **Interface Pin Function**

| Pin No. | Symbol | Level | Description                                  |
|---------|--------|-------|--|
| 1       | VSS    | 0V    | Ground                                       |
| 2       | VDD    | 5.0V  | Supply voltage for logic                     |
| 3       | Vo     |       | Supply voltage for LCD                       |
| 4       | RS     |       | H: Data, L:Instruction                       |
| 5       | R/W    | H/L   | H: Read (MPU←Module) , L: Write (MPU→Module) |
| 6       | E      | H/L   | ENABLE SIGNAL                                |
| 7       | DB0    | H/L   | Data bus line                                |
| 8       | DB1    | H/L   | Data bus line                                |
| 9       | DB2    | H/L   | Data bus line                                |
| 10      | DB3    | H/L   | Data bus line                                |
| 11      | DB4    | H/L   | Data bus line                                |
| 12      | DB5    | H/L   | Data bus line                                |
| 13      | DB6    | H/L   | Data bus line                                |
| 14      | DB7    | H/L   | Data bus line                                |
| 15      | JCi h  |       | Dcg]hjj YJc`hU[YCihdih                       |
| 16      | BZSIC  | N • 1 | Bc7cbbYWJcb                                  |

## **Outline Dimension & Block Diagram**



## **Function Description**

Function Description:

Sys tem interface

ST7920 supports 3 kinds of bus interface to MPU. 8 bits parallel, 4 bits parallel and clock synchronized serial interface. Parallel interface is selected by PSB="I" and serial interface by PSB="0". 8 bit / 4 bit interface is selected by function set instruction DL bit.

Two 8 bit registers (data register DR, instruction register IR) are used in ST7920's write and read operation. Data Register (DR) can access DDRAM/CGRAM/GDRAM and IRAM's data through the address pointer implemented byAddress Counter (AC). Instruction Register (IR) stores the instruction by MPU to ST7920.

4 modes of read/write operation specified by RS and RW:

RS RW description

| L | L | MPU write instruction to instruction register (IR) |
|---|---|--|
| L | Н | MPU read busy flag (BF) and address counter (AC)   |
| Н | L | MPU write data to data register (DR)               |
| Н | Н | MPU read data from data register (DR)              |

#### Busy Flag (BF)

Internal operation is in progress when BF="I", ST7920 is in busy state. No new instruction will be accepted until BF="0". MPU must check BF to determine whether the internal operation is finished and new instruction can be sent.

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### Address counter (AC)

Address counter( AC ) is used for address pointer of DDRAM/CGRAM/IRAM/GDRAM. (AC) can be set by instruction and after data read or write to the memories (AC) will increase or decrease by 1 according to the setting in "entry mode set". When RS="0" and RW= "1" and E="1" the value of ( AC ) will output to DB6~DB0.

#### 16x16 character generation ROM (CGROM) and 8x16 half height ROM (HCGROM)

ST7920 provides character generation ROM supporting 8192 16 x 16 character fonts and 126 8 x 16 alphanumeric characters. It is easy to support multi languages application such as Chinese and English. Two consecutive bytes are used to specify one 16x16 character or two 8x16 half-height characters. Character codes are written into DDRAM and the corresponding fonts are mapped from CGROM or HCGROM to the display drivers.

#### Character generation RAM (CGRAM)

ST7920 provides RAM to support user-defined fonts. Four sets of 16x16 bit map area are available. These user-defined fonts are displayed the same ways as CGROM fonts through writing character cod data to DDRAM

#### ICON RAM (IRAM)

ST7920 provides 240 ICON display. It consists of 15 sets of IRAM address. Each IRAM address has 16 bits data IRAM address should be set first before writing to the IRAM. Two bytes for each address. First higher byte (D15~D8) and then lower byte (D7~D0).

#### Display data RAM ( DDRAM )

There are 64x2 bytes for display data RAM area. Can store display data for 16 characters(16x16) by 4 lines or 32 characters(8x16) by 4 lines. However, only 2 lines can be displayed at a time. Character codes stored in DDRAM point to the fonts specified by CGROM, HCGROM and CGRAM. ST7920 display half height HCGROM fonts, user-defined CGRAM fonts and full 16x16 CGROM fonts. Data codes 0000H~0006H are for CGRAM user-defined fonts. Data codes 02H~7FH are for half height alpha numeric fonts. Data codes (A140--~D75F) are for BIG5 code and (A1A0~F7FF) are for GB code.

- display HCGROM fonts: Write 2 bytes data to DDRAM to display two 8x16 fonts. Each byte represents 1 character font. The data of each byte is 02H~7FH.
- 2. display CGRAM fonts: Write 2 bytes data to DDRAM to display one 16x16 font. Only 0000H, 0002H, 0004H, 0006H are allowed.
- display CGROM fonts: Write 2 bytes data to DDRAM to display one 16x16 font. A140H~D75FH are for (BIG5) code, A1A0H~F7FFH are for (GB) code.

Higher byte (D15--, D8) are written first and then lower byte (D7~DO). Refer to Table 5 for address map

CGRAM fonts and CGROM fonts can only be displayed in the start position of each address. (Refer to Table 4)

80

|   |   | 8 | 1 | 8 | 2 | 8 | 3 | 8 | 4 | 8 |   | 8   | 6 | 8 | 7  | 8  | 8 | 8 | 9 | 8 | Α  | 8 | В | 8 | С | 8 | D | 8 | Е | 8 | F |
|---|---|---|---|---|---|---|---|---|---|---|---|-----|---|---|----|----|---|---|---|---|----|---|---|---|---|---|---|---|---|---|---|
| Н | L | Н | L | Н | L | Н | L | Η | L | Н | L | Н   | L | Н | L  | Η  | L | Н | L | Н | L  | Н | L | Н | L | Н | L | Н | L | Н | L |
| S | ı | t | r | 0 | n |   | Χ |   | S | T | 7 | 9   | 2 | 0 |    |    |   |   |   |   |    |   |   |   |   |   |   |   |   |   |   |
| 砂 | Þ | 倉 |   | 官 |   | 丁 |   | • | • |   | 4 | < \ | て | 紨 | 前開 | 矴  | 馬 |   | ( | Ī | Ξ. | 耐 | 至 | ) | ) |   |   |   |   |   |   |
| 砂 | タ | 倉 |   | 官 | Ī | 一 |   |   |   |   | Ε | þ   | 3 | と | 紛  | 前開 | 租 | 馬 |   |   |    |   |   |   |   |   |   |   |   |   |   |

Table 4

Incorrect position

#### **Graphic RAM (GDRAM)**

Graphic display RAM supports 64x256 bits bit-mapped memory space. GDRAM address is set by writing 2 consecutive bytes for vertical address and horizontal address. Two-bytes data write to GDRAM for one address. Address counter will automatically increase by one for the next two-byte data. The procedure is as followings.

- 1. Set vertical address (Y) for GDRAM
- 2. Set horizontal address (X) for GDRAM
- 3. Write D 15~ D8 to GDRAM (first byte)
- 4. Write D7~D0 to GDRAM (second byte)

Graphic display memory map please refer to Table-8

#### LCD driver

LCD driver have 33 common and 64 segments to drive the LCD panel. Segment data from CGRAM /CGROM/HCGROM are shifted into the 64 bits segment latches to display. Extended segment driver ST7921 can be used to extend the segment drivers to 256.



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Table  $5: \mathbf{DDRAM}$  data ( character code )  $\ \ , \ \mathbf{CGRAM}$  data / address map Note

- 1. DDRAM data (character code) bit1 and bit2 are the same as CGRAM address bit4 and bit5.
- 2. CGRAM address bit0 to bit3 specify total 16 rows. Row16 is for cursor display. The data in row 16 will be logical OR to the cursor.
- 3. CGRAM data for each address is 16 bits.
- 4. DDRAM data to select CGRAM bit4 to bit15 must be "0". Bit0 and bit3 value are "don't care".

| _      | N RAN | Л     |         |                        |            |       |       |            |            | ICC        | ON RA      | AM da      | ita        |            |              |            |            |              |        |
|--------|-------|-------|---------|------------------------|------------|-------|-------|------------|------------|------------|------------|------------|------------|------------|--------------|------------|------------|--------------|--------|
| set II | RAM ( | addre |         | Higher byte Lower byte |            |       |       |            |            |            |            |            |            |            |              |            |            |              |        |
| AC3    | AC2   | AC1   | AC<br>0 | D15                    | D14        | D13   | D12   | D11        | D10        | D9         | D8         | D7         | D6         | D5         | D4           | D3         | D2         | D1           | D0     |
| 0      | 0     | 0     | 0       | SEG0                   | SEG1       | SEG2  | SEG3  | SEG4       | SEG5       | SEG6       | SEG7       | SEG8       | SEG9       | SEG10      | SEG11        | SEG12      | SEG13      | SEG14        | SEG15  |
| 0      | 0     | 0     | 1       | SEG16                  | SEG17      | SEG18 | SEG19 | SEG20      | SEG21      | SEG22      | SEG23      | SEG24      | SEG25      | SEG26      | SEG27        | SEG28      | SEG29      | SEG30        | SEG31  |
| 0      | 0     | 1     | 0       | SEG32                  | SEG33      | SEG34 | SEG35 | SEG36      | SEG37      | SEG38      | SEG39      | SEG40      | SEG41      | SEG42      | SEG43        | SEG44      | SEG45      | SEG46        | SEG47  |
| 0      | 0     | 1     | 1       | SEG48                  | SEG49      | SEG50 | SEG51 | SEG52      | SEG53      | SEG54      | SEG55      | SEG56      | SEG57      | SEG58      | SEG59        | SEG60      | SEG61      | SEG62        | SEG63  |
| 0      | 1     | 0     | 0       | SEG64                  | SEG65      | SEG66 | SEG67 | SEG68      | SEG69      | SEG70      | SEG71      | SEG72      | SEG73      | SEG74      | SEG75        | SEG76      | SEG77      | SEG78        | SEG79  |
| 0      | 1     | 0     | 1       | SEG80                  | SEG81      | SEG82 | SEG83 | SEG84      | SEG85      | SEG86      | SEG87      | SEG88      | SEG89      | SEG90      | SEG91        | SEG92      | SEG93      | SEG94        | SEG95  |
| 0      | 1     | 1     | 0       | SEG96                  | SEG97      | SEG98 | SEG99 | SEG10<br>0 | SEG10<br>1 | SEG10<br>2 | SEG10<br>3 | SEG10<br>4 | SEG10<br>5 | SEG10<br>6 | SEG10<br>7   | SEG10<br>8 | SEG10<br>9 | SEG11<br>0   | SEG111 |
| 0      | 1     | 1     | 1       | SEG112                 | SEG11      | SEG11 | SEG11 | SEG11      | SEG11      | SEG11<br>8 | SEG11      | SEG12      | SEG12      | SEG12      | SEG12        | SEG12      | SEG12      | SEG12        | SEG12  |
| 1      | 0     | 0     | 0       | SEG128                 | SEG12<br>9 | SEG13 | SEG13 | SEG13      | SEG13      | SEG13      | SEG13      | SEG13      | SEG13      | SEG13      | SEG13        | SEG14<br>0 | SEG14      | SEG14        | SEG14  |
| 1      | 0     | 0     | 1       | SEG144                 | SEG14      | SEG14 | SEG14 | SEG14      | SEG14      | SEG15      | SEG15      | SEG15      | SEG15      | SEG15      |              | SEG15      | SEG15      | SEG15        | SEG15  |
| 1      | 0     | 1     | 0       | SEG160                 | SEG16      | SEG16 | SEG16 | SEG16      | SEG16      | SEG16      | SEG16      | SEG16      | SEG16      | SEG17      | SEG17        | SEG17      | SEG17      | SEG17        | SEG17  |
| 1      | 0     | 1     | 1       | SEG176                 | SEG17      | SEG17 | SEG17 | SEG18        | SEG18<br>8 | SEG18      | SEG19        | SEG19  |
| 1      | 1     | 0     | 0       | SEG192                 | _          | SEG19 |       |            | SEG19      | SEG19      | SEG19      | SEG20      | SEG20      | •          | SEG20        | SEG20      | SEG20      | SEG20        | SEG20  |
| 1      | 1     | 0     | 1       | SEG208                 | SEG20      | SEG21 | SEG21 | SEG21      | SEG21      | SEG21      | SEG21      | SEG21      | SEG21      | SEG21      | SEG21        | SEG22      | SEG22      | SEG22        | SEG22  |
| 1      | 1     | 1     | 0       | SEG224                 | SEG22      | SEG22 | SEG22 | SEG22      | SEG22      | SEG23      | SEG23      |            | SEG23      | SEG23      | SEG23        | •          | SEG23      | SEG23        | SEG23  |
| 1      | 1     | 1     | 1       | _                      | <u> </u>   |       | -     |            | 9          | _          | _          | <u></u>    |            |            | <del>-</del> |            |            | <u>8</u><br> |        |

Table 6 ICON RAM address, data and segment pins

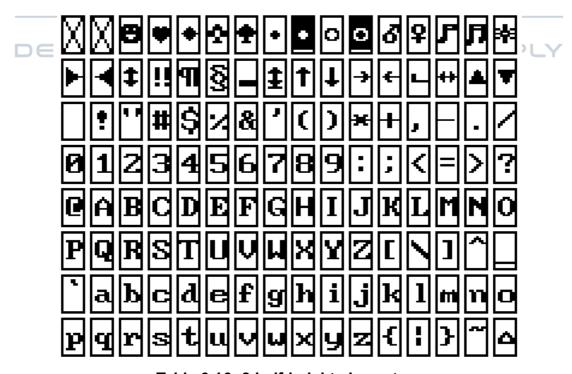


Table 6 16x8 half-height characters

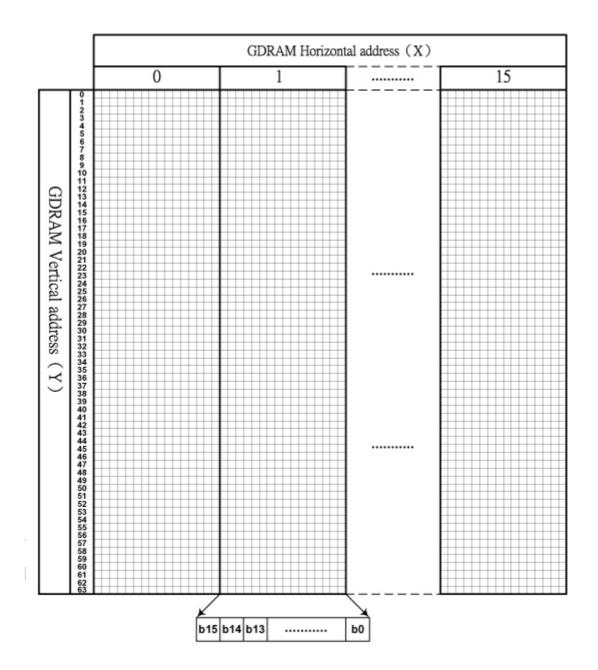


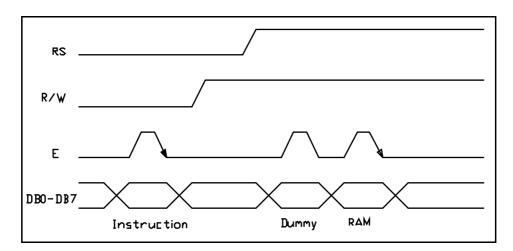
Table 8 GDRAM display coordinates and corresponding address

### Parallel interface

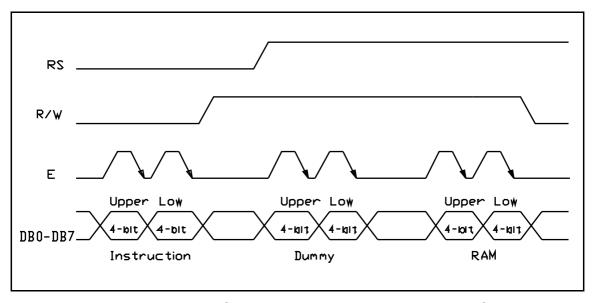
ST7920 is in parallel mode by pulling up PSB pin. And can select 8 bit or 4-bit bus interface by function set instruction DL control bit. MPU can control ( RS , RW , E , and DB0..DB7 ) pins to complete the data transmission.

In 4-bit transfer mode, every 8 bits data or instruction is separated into 2 parts. Higher 4 bits DB7~DB4 data will transfer.

First and placed into data pins (DB7~DB4). Lower 4 bits (DB3~DB0) data will transfer second and placed into data pins (DB7~DB4). (DB3~DB0) data pins are not used.



Timing Diagram of 8-bit Parallel Bus Mode Data Transfer



Timing Diagram of 4-bit Parallel Bus Mode Data Transfer

#### Serial interface:

ST7920 is in serial interface mode when pull down PSB pin. Two pins (SCLK and SID) are used to complete the data transfer. Only write data is available.

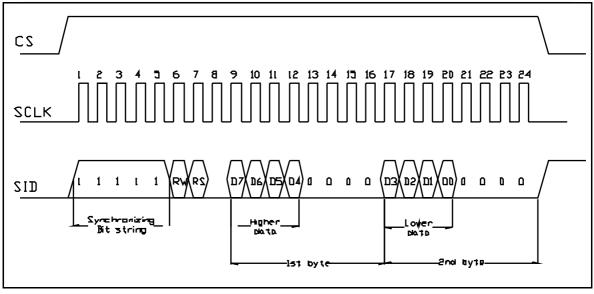
When connecting several ST7920, chip select (CS) must be used. Only when (CS) is high the serial dock (SCLK) can be accepted. On the other hand, when chip select (CS) is low ST7920 serial counter and data will be reset. Transmission will be terminated and data will be cleared. Serial transfer counter is set to the first bit. For a minimal system with only one ST7920 and one MPU.

only SCLK and SID pins are necessary. CS pin should pull to high.

ST7920's serial clock SCLK is asynchronous to the internal clock and is generated by MPU. When multiple instruction/data is transferred instruction execution time must be considered. Must wait for the previous instruction to finish before sending the next. ST7920 has no internal instruction buffer area.

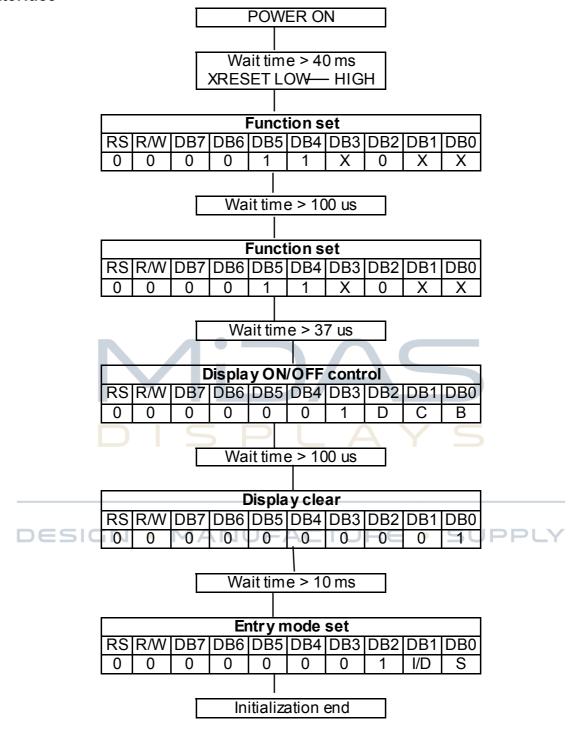
When starting a transmission a start byte is required. It consists of 5 consecutive "1"(sync character). Serial transfer counter will be reset and synchronized. Following 2 bits for read/write (RW) and register/data select (RS). Last 4 bits is filled by "0"

After receiving the sync character and RW and RS bits, every 8 bits instruction/data will be separated into 2 groups. Higher 4 bits (DB7~DB4) will be placed in first section followed by 4 "0". And lower 4 bits DB3~DB0 will be placed in second section followed by 4 "0".

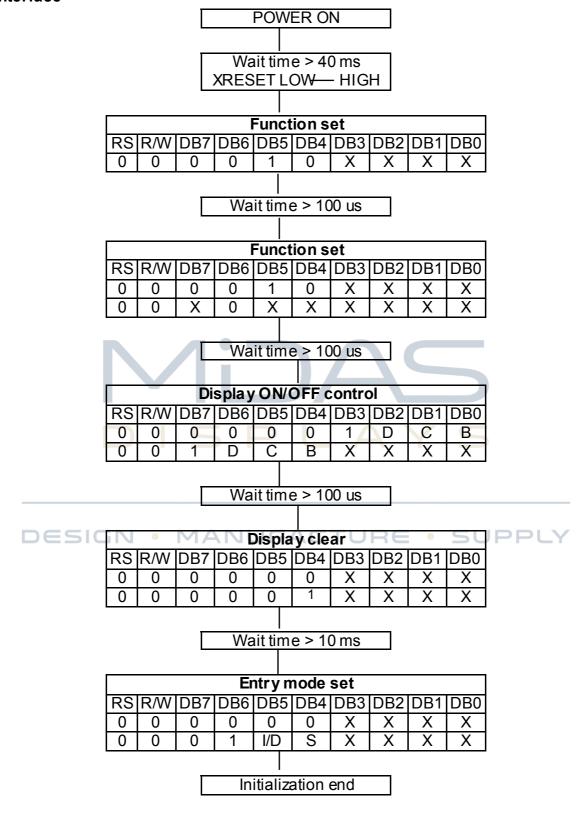


Timing Diagram of Serial Mode Data Transfer

#### 8 bit interface:

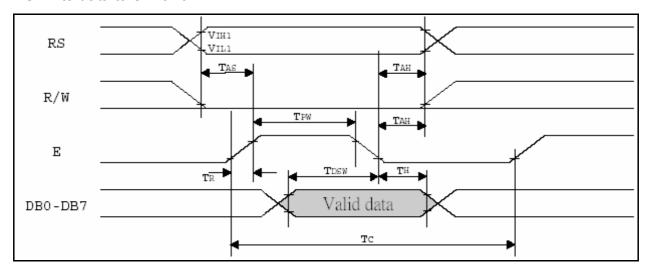


#### 4 bit interface:

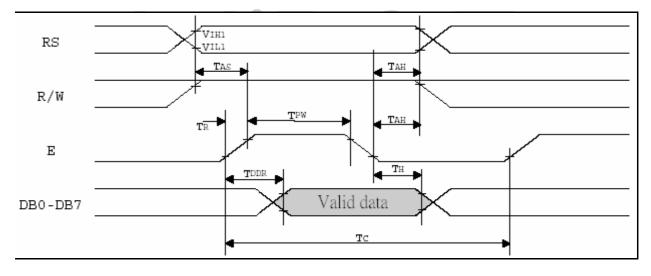


### 8 bit interface timing diagram

#### • MPU write data to ST7920

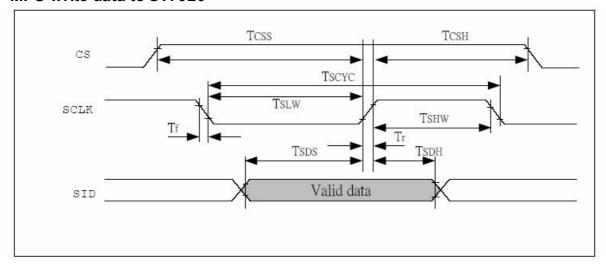


### • MPU read data from ST7920



### Serial interface timing diagram

### • MPU write data to ST7920



**Absolute Mazimum Ratings** 

| Characteristics       | Symbol | Value                          |
|-----------------------|--------|--------------------------------|
| Power Supply Voltage  | Vdd    | -0.3V to +5.5V                 |
| LCD Driver Voltage    | VLCD   | -0.3V to +7.0V                 |
| Input Voltage         | Vin    | -0.3V to V <sub>DD</sub> +0.3V |
| Operating Temperature | TA     | -20°C to +85°C                 |
| Storage Temperature   | Тѕто   | -55°C to +125°C                |

## DC Characteristics (Ta=25°C, VDD=2.7V - 4.5V)

| Symbol           | Characteristics                           | Test Condition                                  | Min.               | Тур. | Max.                   | Unit |
|------------------|---|---|--------------------|------|------------------------|------|
| V <sub>DD</sub>  | Operating Voltage                         | _   | 2.7                | _    | 5.5                    | V    |
| VLCD             | LCD Voltage                               | V0 – Vss  | 3.0                | _    | 5.5                    | V    |
| lcc              | Power Supply<br>Cruuent                   | $fosc = 530KHz$ , $V_{DD} = 3.0V$<br>Rf = 18 kΩ | _                  | 0.20 | 0.45                   | mA   |
| VIH1             | Input High Voltage<br>(Except OSC1)       | _   | 0.7 <b>V</b> DD    | ı    | V <sub>DD</sub>        | V    |
| VIL1             | Input Low Voltage<br>(Except OSC1)        |   | -0.3               | 1    | 0.6                    | V    |
| V <sub>IH2</sub> | Input High Voltage<br>(OSC1)              |   | V <sub>DD</sub> -1 |      | VDD                    | V    |
| VIL2             | Input Low Voltage<br>(OSC1)               | S P-L A   | Y                  | h    | 1.0                    | V    |
| <b>V</b> OH1     | Output High Voltage<br>(DB0 – DB7)        | Iон = -0.1 mA                                   | 0.8V <sub>DD</sub> | ı    | VDD                    | V    |
| Vol1             | Output Low Voltage<br>(DB0 – DB7)         | IoL = 0.1 mA                                    | _                  | _    | 0.1                    | V    |
| V <sub>OH2</sub> | Output High Voltage<br>(Except DB0 – DB7) | Iон = -0.04 mA                                  | 0.8 VDD            | 5UPI | V <sub>DD</sub>        | V    |
| VOL2             | Output Low Voltage<br>(Except DB0 – DB7)  | IoL = 0.04 mA                                   | _                  | _    | 0.1<br>V <sub>DD</sub> | V    |
| ILEAK            | Input Leakage<br>Current                  | VIN = 0V TO VDD                                 | -1                 | _    | 1                      | μа   |
| <b>I</b> PUP     | Pull Up MOS<br>Current                    | V <sub>DD</sub> = 3 V                           | 22                 | 27   | 32                     | μΑ   |

## DC Characteristics (T<sub>A</sub>= 25°C, V<sub>DD</sub> = 4.5 V - 5 V)

| Symbol           | Characteristics                          | Test Condition  | Min.                | Тур. | Max.                   | Unit |
|------------------|--|---|---------------------|------|------------------------|------|
| Vdd              | Operating Voltage                        | _   | 4.5                 | _    | 5.5                    | V    |
| VLCD             | LCD Voltage                              | V0 – Vss  | 3.0                 | _    | 5.5                    | V    |
| lcc              | Power Supply<br>Cruuent                  | fosc = $540$ KHz, $V_{DD} = 5$ V Rf = $33$ k $\Omega$ | _                   | 0.45 | 0.75                   | mA   |
| VIH1             | Input High Voltage<br>(Except OSC1)      | _   | 0.7 <b>V</b> DD     | _    | VDD                    | V    |
| VIL1             | Input Low Voltage<br>(Except OSC1)       | _   | -0.3                | _    | 0.6                    | V    |
| V <sub>IH2</sub> | Input High Voltage<br>(OSC1)             | _   | V <sub>DD</sub> -1  | _    | V <sub>DD</sub>        | V    |
| VIL2             | Input Low Voltage<br>(OSC1)              | _   | _                   | _    | 1.0                    | V    |
| Voн1             | Output High Voltage<br>(DB0 – DB7)       | Iон = -0.1 mA   | 0.8V <sub>DD</sub>  | _    | V <sub>DD</sub>        | V    |
| V <sub>OL1</sub> | Output Low Voltage<br>(DB0 – DB7)        | IoL = 0.1 mA  | -                   |      | 0.4                    | V    |
| V <sub>OH2</sub> | Output High Voltage (Except DB0 – DB7)   | Iон = -0.04 mA  | 0.8 V <sub>DD</sub> |      | <b>V</b> DD            | V    |
| Vol2             | Output Low Voltage<br>(Except DB0 – DB7) | loL = 0.04 mA   |                     |      | 0.1<br>V <sub>DD</sub> | V    |
| ILEAK            | Input Leakage<br>Current                 | VIN = 0V TO VDD                                       | -1                  |      | 1                      | μA   |
| lpup             | Pull Up MOS<br>Current                   | V <sub>DD</sub> = 5 V                                 | 75                  | 80   | 85                     | μA   |

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AC Characteristics (  $T_A = 25$ °C,  $V_{DD} = 4.5$ V) Parallel Mode Interface

| Symbol           | Characteristics                           | Test Condition   | Min.                | Тур. | Max.                   | Unit |
|------------------|---|--|---------------------|------|------------------------|------|
|                  |   | Internal Clock Operation                                 |                     |      |                        |      |
| fosc             | LCD Voltage                               | V0 - Vss   | 3.0                 | _    | 7                      | V    |
| <b>f</b> ∈x      | Power Supply<br>Cruuent                   | fosc = $540$ KHz, $V_{DD} = 5$ V<br>Rf = $33$ k $\Omega$ | _                   | 0.45 | 0.75                   | mA   |
| VIH1             | Input High Voltage<br>(Except OSC1)       | _  | 0.7 V <sub>DD</sub> | _    | V <sub>DD</sub>        | V    |
| VIL1             | Input Low Voltage<br>(Except OSC1)        | _  | -0.3                | 1    | 0.6                    | V    |
| V <sub>IH2</sub> | Input High Voltage<br>(OSC1)              | _  | V <sub>DD</sub> -1  | _    | V <sub>DD</sub>        | V    |
| VIL2             | Input Low Voltage<br>(OSC1)               | _  | _                   | _    | 1.0                    | V    |
| Voн1             | Output High Voltage<br>(DB0 – DB7)        | Iон = -0.1 mA  | 0.8V <sub>DD</sub>  | _    | VDD                    | V    |
| V <sub>OL1</sub> | Output Low Voltage<br>(DB0 – DB7)         | IoL = 0.1 mA   | -                   | 1    | 0.4                    | V    |
| <b>V</b> OH2     | Output High Voltage<br>(Except DB0 – DB7) | Iон = -0.04 mA   | 0.8 V <sub>DD</sub> |      | V <sub>DD</sub>        | V    |
| <b>V</b> OL2     | Output Low Voltage<br>(Except DB0 – DB7)  | IoL = 0.04 mA  | _                   |      | 0.1<br>V <sub>DD</sub> | V    |
| ILEAK            | Input Leakage<br>Current                  | VIN = 0V TO VDD  | -1                  | S    | 1                      | μΑ   |
| <b>I</b> PUP     | Pull Up MOS<br>Current                    | V <sub>DD</sub> = 5 V                                    | 75                  | 80   | 85                     | μΑ   |

## DESIGN • MANUFACTURE • SUPPLY

## AC Characteristics ( $T_A = 25$ °C, $V_{DD} = 4.5$ V) Parallel Mode Interface

| Symbol                         | Characteristics          | Test Condition                | Min.       | Тур. | Max.     | Unit |
|--------------------------------|--------------------------|-------------------------------|------------|------|----------|------|
|                                |                          | Internal Clock Operation      |            |      | <u> </u> |      |
| fosc                           | OSC Frequency            | R=33kΩ                        | 480        | 540  | 600      | KHz  |
|                                |                          | External Clock Operation      |            |      | •        |      |
| f∈x                            | External Frequency       | _                             | 480        | 540  | 600      | KHz  |
|                                | Duty Cycle               | _                             | 45         | 50   | 55       | %    |
| T <sub>R</sub> ,T <sub>F</sub> | Rise/Fall Time           | _                             | _          | _    | 0.2      | μS   |
|                                | Write M                  | ode (Writing data from MPU to | ST7920     | )    |          |      |
| Тс                             | Enable Cycle Time        | Pin E                         | 1200       | _    | _        | nS   |
| Tpw                            | Enable Pulse Width       | Pin E                         | 140        | _    | _        | nS   |
| T <sub>R</sub> ,T <sub>F</sub> | Enable Rise/Fall<br>Time | Pin E                         | _          | _    | 25       | nS   |
| Tas                            | Address Setup Time       | Pins : RS,RW,E                | 10         | ١    | _        | nS`  |
| Тан                            | Address Hold Time        | Pins : RS,RW,E                | 20         | ı    | _        | nS   |
| Tosw                           | Data Setup Time          | Pins : DB0-DB7                | 40         |      | _        | nS   |
| Тн                             | Data Hold Time           | Pins : DB0-DB7                | 20         |      |          | nS   |
|                                | Read Mo                  | ode (Reading Data from ST792  | 20 to MPU  | J)   |          |      |
| Тс                             | Enable Cycle Time        | Pin : E                       | 1200       | _    | _        | nS   |
| T <sub>PW</sub>                | Enable Pulse Width       | Pin : E                       | 140        | _    | _        | nS   |
| TR,TF                          | Enable Rise/Fall         | Pin : E<br>MANUFACTURE        | = <u> </u> | 5UP  | 25       | , nS |
| Tas                            | Address Setup Time       | Pins : RS,RW,E                | 10         | _    | _        | nS   |
| Тан                            | Address Hold Time        | Pins : RS,RW,E                | 20         | _    | _        | nS   |
| TDDR                           | Data Delay Time          | Pins: DB0-DB7                 | _          | _    | 100      | nS   |
| Тн                             | Data Hold Time           | Pins: DB0-DB7                 | 20         | _    | _        | nS   |
|                                | Interf                   | ace Mode with LCD Driver (S   | Г7921)     |      |          |      |
| Tcwn                           | Clock Pulse with<br>High | Pins: CL1, CL2                | 800        | _    | _        | nS   |
| TcwL                           | Clock Pulse With<br>Low  | Pins : CL1, CL2               | 800        | _    | _        | nS   |
| Тсѕт                           | Clock Setup time         | Pins : CL1, CL2               | 500        | _    | _        | nS   |
| Tsu                            | Data Setup Time          | Pin : D                       | 300        | _    | _        | nS   |
| Том                            | Data Hold Time           | Pin : D                       | 300        | _    | _        | nS   |
| Tpw                            | Enable Pulse Width       | Pin : M                       | -1000      | _    | 1000     | nS   |

## AC Characteristics ( $T_A = 25$ °C, $V_{DD} = 2.7$ V) Parallel Mode Interface

| Symbol                                      | Characteristics          | Test Condition                | Min.   | Тур. | Max.     | Unit |  |  |  |  |  |
|---|--------------------------|-------------------------------|--------|------|----------|------|--|--|--|--|--|
|   |                          | Internal Clock Operation      |        |      | <u> </u> |      |  |  |  |  |  |
| fosc  | OSC Frequency            | R=18kΩ                        | 470    | 530  | 590      | KHz  |  |  |  |  |  |
|   |                          | External Clock Operation      |        |      |          |      |  |  |  |  |  |
| f∈x   | External Frequency       | _                             | 470    | 530  | 590      | KHz  |  |  |  |  |  |
|   | Duty Cycle               | _                             | 45     | 50   | 55       | %    |  |  |  |  |  |
| TR,TF                                       | Rise/Fall Time           | _                             | _      | _    | 0.2      | μS   |  |  |  |  |  |
|   | Write Mo                 | ode (Writing data from MPU to | ST7920 | )    |          |      |  |  |  |  |  |
| Тс  | Enable Cycle Time        | Pin E                         | 1800   | _    | _        | nS   |  |  |  |  |  |
| Tpw   | Enable Pulse Width       | Pin E                         | 160    | _    | _        | nS   |  |  |  |  |  |
| TR,TF                                       | Enable Rise/Fall<br>Time | Pin E                         | _      | _    | 25       | nS   |  |  |  |  |  |
| Tas   | Address Setup Time       | Pins : RS,RW,E                | 10     | _    | _        | nS`  |  |  |  |  |  |
| Тан   | Address Hold Time        | Pins : RS,RW,E                | 20     | -    | _        | nS   |  |  |  |  |  |
| Tosw  | Data Setup Time          | Pins : DB0-DB7                | 40     |      | _        | nS   |  |  |  |  |  |
| Тн  | Data Hold Time           | Pins : DB0-DB7                | 20     |      |          | nS   |  |  |  |  |  |
| Read Mode (Reading Data from ST7920 to MPU) |                          |                               |        |      |          |      |  |  |  |  |  |
| Тс  | Enable Cycle Time        | Pin : E                       | 1800   | _    | _        | nS   |  |  |  |  |  |
| Tpw   | Enable Pulse Width       | Pin : E                       | 320    | _    | _        | nS   |  |  |  |  |  |
| TR,TF                                       | Enable Rise/Fall         | MANUFACTURE                   | = - 9  | 5UP  | 25       | , nS |  |  |  |  |  |
| Tas   | Address Setup Time       | Pins : RS,RW,E                | 10     | _    | _        | nS   |  |  |  |  |  |
| Тан   | Address Hold Time        | Pins : RS,RW,E                | 20     | -    | _        | nS   |  |  |  |  |  |
| Todr  | Data Delay Time          | Pins: DB0-DB7                 | _      | _    | 260      | nS   |  |  |  |  |  |
| Тн  | Data Hold Time           | Pins: DB0-DB7                 | 20     | _    | _        | nS   |  |  |  |  |  |
|   | Interf                   | ace Mode with LCD Driver (ST  | Г7921) |      |          |      |  |  |  |  |  |
| Тсwн  | Clock Pulse with<br>High | Pins: CL1, CL2                | 800    | _    | _        | nS   |  |  |  |  |  |
| TcwL  | Clock Pulse With<br>Low  | Pins : CL1, CL2               | 800    | _    | _        | nS   |  |  |  |  |  |
| Тсѕт  | Clock Setup time         | Pins: CL1, CL2                | 500    | _    | _        | nS   |  |  |  |  |  |
| Tsu   | Data Setup Time          | Pin : D                       | 300    | _    | _        | nS   |  |  |  |  |  |
| Том   | Data Hold Time           | Pin : D                       | 300    | _    | _        | nS   |  |  |  |  |  |
| Tpw   | Enable Pulse Width       | Pin : M                       | -1000  | _    | 1000     | nS   |  |  |  |  |  |

# **Display Control Instruction**

### Instructions

ST7920 offers basic instruction set and extended instruction set:

| laa                                 | code Description |    |     |             |     |     |     |         | Description | Exec time |  |          |
|-------------------------------------|------------------|----|-----|-------------|-----|-----|-----|---------|-------------|-----------|--|----------|
| Ins                                 | RS               | RW | DB7 | DB6         | DB5 | DB4 | DB3 | DB2     | DB1         | DB0       |  | (540KHZ) |
| CLEAR                               | 0                | 0  | 0   | 0           | 0   | 0   | 0   | 0       | 0           | 1         | Fill DDRAM with "20H", and set DDRAM address counter (AC) to "00H"   | 1.6 ms   |
| HOME                                | 0                | 0  | 0   | 0           | 0   | 0   | 0   | 0       | 1           | Х         | Set DDRAM address counter (AC) to<br>"00H", and put cursor to origin; to content<br>of DDRAM are not changed.          | 72 us    |
| ENTRY<br>MODE                       | 0                | 0  | 0   | 0           | 0   | 0   | 0   | 1       | I/D         | S         | Set cursor position and shift when doing write or read operation.  | 72 us    |
| DISPLAY<br>ON/OFF                   | 0                | 0  | 0   | 0           | 0   | 0   | 1   | D       | С           | В         | D=1 : displayON<br>C=1 : cursor ON<br>B=1 : blinkON  | 72 us    |
| CURSOR<br>DISPLAY<br>CONTROL        | 0                | 0  | 0   | 0           | 0   | 1   | S/C | R/L     | х           | х         | Cursor position and display shift control; the content of DDRAM are not changed.                                       | 72 us    |
| FUNCTION<br>SET                     | 0                | 0  | 0   | 0           | 1   | DL  | X   | 0<br>RE | Х           | Х         | DL=1 8-BIT interface DL=0 4-BIT interface RE=1: extended instruction RE=0: basic instruction                           | 72 us    |
| SET<br>CGRAM<br>ADDR.               | 0                | 0  | 0   | 1           | AC5 | AC4 | AC3 | AC2     | AC1         | AC0       | Set CGRAM address to address counter (AC)  Make sure that in extended instruction  SR=0 (scroll or RAM address select) | 72 us    |
| SET<br>DDRAM<br>ADDR.               | 0                | 0  | 1   | 0<br>AC6    | AC5 | AC4 | AC3 | AC2     | AC1         | AC0       | Set DDRAM address to address counter(AC) AC6 is fixed to 0   | 72 us    |
| READ<br>BUSY<br>FLAG(BF)<br>& ADDR. | 0                | 1  | BF  | AC6         | AC5 | AC4 | AC3 | AC2     | AC1         | AC0       | Read bus y flag (BF) for completion of internal operation, also<br>Read out the value of address<br>counter(AC)        | 0 us     |
| WRITE<br>RAM                        | Œ                | 6  | D7  | <b>J</b> D6 | D5  | D4  | D3  | D2      | D1/         | D0        | Write data to internal RAM<br>(DDRAM/CGRAM/IRAM/GDRAM)   | 72 us    |
| READ RAM                            | 1                | 1  | D7  | D6          | D5  | D4  | D3  | D2      | D1          | D0        | Read data from internal RAM (DDRAM/CGRAM/IRAM/GDRAM)   | 72 us    |

### Instruction set 2: (RE=1: extended instruction)

| Ins                                 |    |     |            |          | СО       | de       |            |            |            |     | Description   | Exec time |
|-------------------------------------|----|-----|------------|----------|----------|----------|------------|------------|------------|-----|---|-----------|
| IIIS                                | RS | RW  | DB7        | DB6      | DB5      | DB4      | DB3        | DB2        | DB1        | DB0 |   | (540KHZ)  |
| STA ND BY                           | 0  | 0   | 0          | 0        | 0        | 0        | 0          | 0          | 0          | 1   | Enter stand by mode, any other instruction can terminate (Com132 halted, only Com33 ICON can display)   | 72 us     |
| SCROLL or<br>RAM<br>ADDR.<br>SELECT | 0  | 0   | 0          | 0        | 0        | 0        | 0          | 0          | 1          | SR  | SR=1 : enable vertical scroll position SR=0 : enable IRAM address (extended instruction) SR=0 : enable CGRAM address (basic instruction)  | 72 us     |
| REVERSE                             | 0  | 0   | 0          | 0        | 0        | 0        | 0          | 1          | R1         |     | Select 1 out of 4 line (in DDRAM) and decide whether to reverse the display by toggling this instruction.  R1, R0 initial value is 00   | 72 us     |
| SLEEP                               | 0  | 0   | 0          | 0        | 0        | 0        | 1          | SL         | Х          | х   | SL=1: leave sleep mode<br>SL=0: enter sleep mode  | 72 us     |
| EXTENDED<br>FUNCTION<br>SET         | 0  | 0   | 0          | 0        | 1        | DL       | X          | 1<br>RE    | G          | 0   | DL=1 8-BIT interface DL=0 4-BIT interface  RE=1: extended instruction  RE=0: basic instruction  G=1: graphic display ON G=0: graphic display OFF  | 72 us     |
| SET IRAM<br>or SCROLL<br>ADDR       | 0  | 0   | 0          | 1        | AC5      | AC4      | AC3        | AC2        | AC1        | AC0 | SR=1: AC5~AC0 the address of vertical scroll SR=0: AC3~AC0 the address of ICON RAM  | 72 us     |
| SET<br>GRA PHIC<br>RAM<br>ADDR.     | 0  | 510 | <b>5</b> N | 0<br>AC6 | 0<br>AC5 | 0<br>AC4 | AC3<br>AC3 | AC2<br>AC2 | AC1<br>AC1 | AC0 | Set CGRAM address to address counter (AC) First set vertical address and the horizontal address by consecutive writing. Vertical address range AC6. AC0 Horizontal address range AC3AC0 | 72 us     |

#### Note:

- 1. Make sure that ST7920 is not in busy state by reading the busy flag before sending instruction or data. If use delay loop instead please make sure the delay time is enough. Please refer to the instruction execution time.
- 2. "RE" is the selection bit of basic and extended instruction set. Each time when altering the value of RE it will remain. There is no need to set RE every time when using the same group of instruction set.

## Initial setting(Register flag) (RE=0: basic instruction)

| Ins               | COC | de |         |         |         |         |         |         |                                       |                                      | Description                                      |  |
|-------------------|-----|----|---------|---------|---------|---------|---------|---------|---------------------------------------|--------------------------------------|--|--|
|                   | RS  | RW | DB<br>7 | DB<br>6 | DB<br>5 | DB<br>4 | DB<br>3 | DB<br>2 | DB<br>1                               | DB<br>0                              |  |  |
| ENTRY             | 0   | 0  | 0       | 0       | 0       | 0       | 0       | 1       | I/D                                   | S                                    | Cursor move to right, DDRAM address counter (AC) |  |
| MODE SET          |     |    |         |         |         |         |         |         | 1                                     | 0                                    | plus 1   |  |
| DISPLAY           | 0   | 0  | 0       | 0       | 0       | 0       | 1       | D       | С                                     | В                                    | Display, cursor and blink ALL OFF                |  |
| STATUS            |     |    |         |         |         |         |         | 0       | 0                                     | 0                                    | Display, Guisor and Billikale Or i               |  |
| CURSOR<br>DISPLAY | 0   | 0  | 0       | 0       | 0       | 1       | S/C     | R/L     | Х                                     | Х                                    | No cursor or display shift operation             |  |
| SHIFT             |     |    |         |         |         |         | х       | x       |                                       | No cursor or display shift operation |  |  |
| FUNCTION          | 0   | 0  | 0       | 0       | 1       | DL      | Х       | o<br>RE | Х                                     | Х                                    | 8 BIT MPU interfce, basic instruction set        |  |
| SET               |     |    |         |         |         | 1       |         | 0       | O DIT IVIF O IIILETICE, DASIC IIISLIU |                                      | o bit wif o interice, basic instruction set      |  |

## Initial setting(Register flag) (RE=1 : extended instruction set)

| Ins               | COC | de |         |         |         |         |         |         |         |         | Description                              |  |  |  |  |  |  |
|-------------------|-----|----|---------|---------|---------|---------|---------|---------|---------|---------|--|--|--|--|--|--|--|
|                   | RS  | RW | DB<br>7 | DB<br>6 | DB<br>5 | DB<br>4 | DB<br>3 | DB<br>2 | DB<br>1 | DB<br>0 |  |  |  |  |  |  |  |
| SCROLL<br>OR RAM  | 0   | 0  | 0       | 0       | 0       | 0       | 0       | 1_      | 1_      | SR      | Allow IRAM address or set CGRAM address  |  |  |  |  |  |  |
| ADDR.<br>SELECT   |     |    |         |         |         |         |         |         |         | 0       | FACTURE • SUPPLY                         |  |  |  |  |  |  |
| REVERSE           | 0   | 0  | 0       | 0       | 0       | 0       | 0       | 1       | R1      | R0      | Begin with normal and toggle to reverse  |  |  |  |  |  |  |
|                   |     |    |         |         |         |         |         |         | 0       | 0       | Bogiii wariioiiiia ana toggio to revereo |  |  |  |  |  |  |
| SLEEP             | 0   | 0  | 0       | 0       | 0       | 0       | 1       | SL      | Х       | Х       | Not in sleep mode                        |  |  |  |  |  |  |
| <u> </u>          |     |    |         |         |         |         |         | 1       |         |         | Not in Gloop mode                        |  |  |  |  |  |  |
| EXTENDED FUNCTION | 0   | 0  | 0       | 0       | 1       | DL      | X       | 0<br>RE | G       | X       | Graphic display OFF                      |  |  |  |  |  |  |
| SET               |     |    |         |         |         |         |         |         | 0       |         | Grapino display Of 1                     |  |  |  |  |  |  |

#### **Description of basic instruction set**

#### • CLEAR

Fill DDRAM with "20H"(space code). And set DDRAM address counter (AC to "00H". Set entry mode I/D bit to be "1".

Cursor moves right and AC adds 1 after write or read operation.

#### • HOME

Set DDRAM address counter AC to "00H". Cursor moves to origin. Then content of DDRAM is not changed.

#### • ENTRY MODE SET

Set the cursor movement and display shift direction when doing write or read operation.

#### I/D :address counter increase / decrease

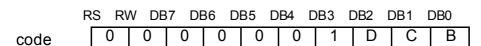
When I/D = "1", cursor moves right, DRAM address counter AC add by 1.

When I/D = "0", cursor moves left, DRAM address counter AC subtract by 1.

#### S: Display shift

| S | I/D | DESCRIPTION                     |
|---|-----|---------------------------------|
| Н | Н   | Entire display shift left by 1  |
| Н | L   | Entire display shift right by 1 |

## • DISPLAYSTATUS N • MANUFACTURE • SUPPL



Controls display, cursor and blink ON/OFF.

#### D: Display ON/OFF control bit

When D = "1", display ON

When D = "0", display OFF, the content of DDRAM is not changed

#### C: Cursor ON/OFF control bit

When C = "1", cursor ON.

When C = "0", cursor OFF.

#### B: Blink ON/OFF control bit

When B = "1", cursor position blink ON. Then display data in cursor position will blink.

When B = "0", cursor position blink OFF

#### • CURSOR AND DISPLAY SHIFT CONTROL

Instruction to move the cursor or shift the entire display. The content of DDRAM is not changed.

| S/C | R/L | Description   | AC Value |
|-----|-----|---|----------|
| L   | L   | Cursor moves left by 1                                  | AC=AC-1  |
| L   | Н   | Cursor moves right by 1                                 | AC=AC+1  |
| Н   | L   | Display shift left by 1, cursor also follows to shift.  | AC=AC    |
| Н   | Н   | Display shift right by 1, cursor also follows to shift. | AC=AC    |

#### • FUNCTION SET

|      | RS | RW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|------|----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0  | 0   | 0   | 1   | DL  | X   | RE  | X   | X   |

DL: 4/8 BIT interface control bit

When DL = "1", 8 BIT MPU bus interface

When DL = "0", 4 BIT MPU bus interface

RE: extended instruction set control bit

When RE = "1", extended instruction set

When RE = "0", basic instruction set

In same instruction cannot alter DL and RE at once. Make sure that change DL first then RE = SUPPLY

#### • SET CGRAM ADDRESS

Set CGRAM address to address counter AC

AC range is 00H..3FH

Make sure that in extended instruction SR=0 (scroll address or RAM address select)

#### SET DDRAM ADDRESS

Set DDRAM address to address counter (AC).

First line AC range is 80H..8FH

Second line AC range is 90H..9FH

Third line AC range is A0H..AFH

Fourth line AC range is B0H..BFH

Please note that only 2 lines can be display at a time.

#### • READ BUSY FLAG (BF) AND ADDRESS

Read busy flag BF can check whether internal operation is finished. At the same time the value of address counter (AC) is also read. When BF = "1" new instruction will not be accepted. Must wait for BF = "0" for new instruction.

#### WRITE DATA TO RAM

Write data to internal RAM and alter the (AC) by 1

Each RAM address (CGRAM,DDRAM,IRAM.....) must write 2 consecutive bytes for 16 bit data. After the second byte the address counter will add or subtract by 1 according to the entry mode set control bit.

#### READ RAM DATA

Read data from internal RAM and alter the (AC) by 1

After address set to read (CGRAM, DDRAM, IRAM.....) a DUMMY READ is required.

There is no need to DUMMY READ for the following bytes unless a new address set instruction is issued.

#### Description of extended instruction set

#### • STAND BY

|      | RS | RW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|------|----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 1   |

Instruction to enter stand by mode. Any other instruction follows this instruction can terminate stand by.

The content of DDRAM remain the same.

#### • VERTICAL SCROLL OR RAM ADDRESS SELECT

|      | RS | RW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|------|----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0  | 0   | 0   | 0   | 0   | 0   | 0   | 1   | SR  |

When SR = "1", the vertical scroll address set is enabled.

When SR = "0", the IRAM address set <u>(extended instruction)</u> and CGRAM address set(<u>basic instruction</u>) is enabled.

#### • REVERSE



Select 1 out of 4 lines to reverse the display and to toggle the reverse condition by repeating this instruction.

R1,R0 initial vale is 00. When set the first time the display is reversed and set the second time the display become normal.

| DESIC | R1 | R0 | MANUF Description RE • 5U     |
|-------|----|----|-------------------------------|
|       | L  | L  | First line nomal or reverse   |
|       | L  | Н  | Second line nomal or reverse  |
|       | Н  | L  | Third line nomal or reverse   |
|       | Н  | Н  | Fourth line normal or reverse |

Please note that only 2 lines out of 4 line display data can be displayed.

#### • SLEEP

|      | RS | RW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|------|----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0  | 0   | 0   | 0   | 0   | 1   | SL  | 0   | 0   |

SL=1: leave sleep mode SL=0: enter sleep mode

PPLY

#### • EXTENED FUNCTION SET

|      | RS | RW | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|------|----|----|-----|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0  | 0   | 0   | 1   | DL  | X   | RE  | G   | X   |

#### DL: 4/8 BIT interface control bit

When DL = "1", 8 BIT MPU interface

When DL = "0", 4 BIT MPU interface

#### RE: extended instruction set control bit

When RE = "1", extended instruction set

When RE = "0", basic instruction set

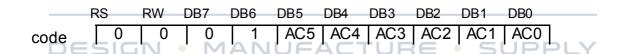
#### G: Graphic display control bit

When G = "1", graphic display ON

When G = "0", Graphic display OFF

In same instruction cannot alter DL, RE and G at once. Make sure that change DL or G first and then RE.

#### SET IRAM OR SCROLL ADDRESS



SR=1: AC5~AC0 is vertical scroll displacement address

SR=0: AC3~AC0 is ICON RAM address

#### • SET GRAPHIC RAM ADDRESS

|      | RS |   |   |     |     |     |     |     |     |     |
|------|----|---|---|-----|-----|-----|-----|-----|-----|-----|
| code | 0  | 0 | 1 | AC6 | AC5 | AC4 | AC3 | AC2 | AC1 | AC0 |

Set GDRAM address to address counter AC.

First set vertical address and then horizontal address (write 2 consecutive bytes to complete vertical and horizontal address set)

Vertical address range is AC6...AC0

Horizontal address range is AC3...AC0

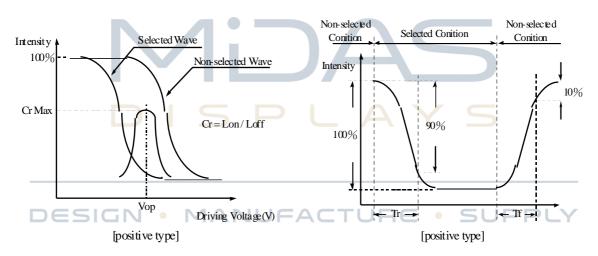
The address counter AC of graphic RAM(GRAM) only increment after write for horizontal address. After horizontal address=0FH it will automatically back to 00H. However, the vertical address will not increase as the result of the same action.

## **Optical Characteristics**

| ltem           | Symbol | Condition | Min | Тур | Max | Unit |
|----------------|--------|-----------|-----|-----|-----|------|
| View Angle     | (V)θ   | CR≧2      | 20  |     | 40  | deg  |
|                | (Η)φ   | CR≧2      | -30 | _   | 30  | deg  |
| Contrast Ratio | CR     | _         | _   | 3   | _   | _    |
| Response Time  | Trise  | _         | _   | 200 | 300 | ms   |
|                | T fall | _         | _   | 200 | 300 | ms   |

**Definition of Operation Voltage (Vop)** 

**Definition of Response Time (Tr, Tf)** 

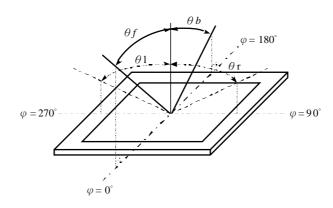


#### **Conditions:**

 $\mbox{Operating Voltage: Vop} \qquad \mbox{Viewing Angle}(\ \theta \ \ , \ \ \phi \ ) : 0^{\circ} \ , \quad 0^{\circ}$ 

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

### Definition of viewing angle ( $CR \ge 2$ )



# **Absolute Maximum Ratings**

| ltem                     | Symbol              | Min | Тур | Max      | Unit                   |
|--------------------------|---------------------|-----|-----|----------|------------------------|
| Operating Temperature    | T <sub>OP</sub>     | -20 | _   | +70      | $^{\circ}\mathbb{C}$   |
| Storage Temperature      | T <sub>ST</sub>     | -30 | _   | +80      | $^{\circ}\!\mathbb{C}$ |
| Input Voltage            | V <sub>I</sub>      | 0   | _   | $V_{DD}$ | V                      |
| Supply Voltage For Logic | $V_{DD}$            | 0   | _   | 6.7      | V                      |
| Supply Voltage For LCD   | VDD-V <sub>SS</sub> | 0   | _   | 7.0      | V                      |

## **Electrical Characteristics**

| Item                     | Symbol              | Condition         | Min               | Тур      | Max      | Unit |
|--------------------------|---------------------|-------------------|-------------------|----------|----------|------|
| Supply Voltage For Logic | $V_{DD}$ - $V_{SS}$ | <b>J</b> /        | 4.5               | 5.0      | 5.5      | V    |
| Supply Voltage For LCD   | 5                   | Ta=-20℃           | A'                | \_<br> - | 5 í È    | V    |
| *Note                    | $V_{O-}V_{SS}$      | Ta=25℃            | 4.F               | 4.H      | 4.Í      | V    |
|                          |                     | Ta=+70℃           | ΙÈG               | _        | _        | V    |
| Input High Volt.         | · MHNU              | JEACT             | $0.7V_{DD}$       | -5       | $V_{DD}$ | LY   |
| Input Low Volt.          | $V_{lL}$            | _                 | -0.3              | _        | 0.6      | V    |
| Output High Volt.        | V <sub>OH</sub>     | _                 | $0.8V_{DD}$       | _        | $V_{DD}$ | V    |
| Output Low Volt.         | $V_{OL}$            | _                 | 0                 | _        | 0.1      | V    |
| Supply Current           | I <sub>DD</sub>     | — <b>////////</b> | <del>((((()</del> | 1.5      | 3        | mA   |

## **Backlight Information**

### **Specification**

| PARAMETER             | SYMBOL | MIN  | TYP | MAX | UNIT              | TEST CONDITION |
|-----------------------|--------|------|-----|-----|-------------------|----------------|
| Supply Current        | ILED   | 14.4 | 16  | 20  | mA                | V=3.5V         |
| Supply Voltage        | V      | 3.4  | 3.5 | 3.6 | V                 | _              |
| Reverse Voltage       | VR     | _    | _   | 5   | V                 | _              |
| Luminous<br>Intensity | IV     | 264  | 330 | _   | CD/M <sup>2</sup> | ILED=16mA      |
| LED Life Time         | _      | _    | 50K | _   | Hr.               | ILED≦16mA      |
| Color                 | White  |      |     |     |                   |                |

Note: The LED of B/L is drive by current only, drive voltage is for reference only. Drive voltage can make driving current under safety area (current between minimum and maximum).





## Reliability

### Content of Reliability Test (wide temperature, -20°C ~70°C)

|   | Environmental Test   |   |      |
|---|--|---|------|
| Test Item                               | Content of Test  | Test Condition  | Note |
| High Temperature storage                | Endurance test applying the high storage temperature for a long time.  | 80℃<br>200hrs   | 2    |
| Low Temperature storage                 | Endurance test applying the high storage temperature for a long time.  | -30℃<br>200hrs  | 1,2  |
| High Temperature Operation              | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.   | 170°C   |      |
| Low Temperature Operation               | Endurance test applying the electric stress under low temperature for a long time.   | 200hrs  | 1    |
| High Temperature/<br>Humidity Operation | The module should be allowed to stand at 60°C,90%RH max  For 96hrs under no-load condition excluding the polarizer,  Then taking it out and drying it at normal temperature. | 60°C ,90%RH<br>96hrs  | 1,2  |
| Thermal shock resistance                | The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C  | -20℃ /70℃<br>10 cycles  |      |
| DESIG                                   | 30min 5min 30min  1 cycle UFACTURE   | • SUPPL   | Y    |
| Vibration test                          | Endurance test applying the vibration during transportation and using.   | Total fixed amplitude: 15mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of XY,Z for Each 15 minutes | :    |
| Static electricity test                 | Endurance test apply ing the electric stress to the terminal.  | VS=800V,RS=1.5kΩ<br>CS=100pF<br>1 time  |      |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

# Inspection specification

| NO   | Item  |   |  | Criterion  |                                 | AQL      |  |  |
|------|---|---|--|--|---------------------------------|----------|--|--|
| 01   | Electrical<br>Testing                               | defect. 1.2 Missing cha 1.3 Display mal 1.4 No function | racter, d<br>function.<br>or no dis<br>sumption<br>g angle d<br>uct types. | play.<br>exceeds product<br>efect.   |                                 | 0.65     |  |  |
| 02   | Black or<br>white spots<br>on LCD<br>(display only) | than three v<br>2.2 Densely sp<br>3mm                   | vhite or b<br>aced: No   | ts on display ≦0.2<br>lack spots present<br>more than two sp                 |                                 | 2.5      |  |  |
| 03 [ | LCD black<br>spots, white<br>spots,<br>contaminatio | 3.1 Round type Φ=(x+y)/                                 | 72   | ature  | SUPPLY                          | 2.5      |  |  |
|      | n<br>(a.a.a.ala.)                                   | 3.2 Line type : (                                       | (As follow   | ving drawing)  |                                 |          |  |  |
|      | (non-display)                                       | _ <b>/</b> ¥ w  | Length   | Width  | Acceptable Q<br>TY              |          |  |  |
|      |   | → L +   |  | W≦0.02   | Accept no dense                 | 2.5      |  |  |
|      |   |   | L≦3.0<br>L≦2.5   | 0.02 <w≦0.03<br>0.03<w≦0.05< td=""><td>2</td><td></td></w≦0.05<></w≦0.03<br> | 2                               |          |  |  |
|      |   |   |  | 0.05 < W   | As round type                   |          |  |  |
|      |   | If bubbles are vijudge using bla                        | ick spot<br>not  | Size Φ<br>Φ≤0.20   | Acceptable Q<br>TY<br>Accept no |          |  |  |
| 04   | Polarizer   | easy to find, mu  | ust  | 3.23   | dense                           | 2.5      |  |  |
|      | bubbles   | check in specify direction.                             | neck in specify $0.20 < \Phi \le 0.50$ 3                                   |  |                                 |          |  |  |
|      |   | unecuon.  |  | 0.50 < Φ≦1.00  | 2                               | <b>-</b> |  |  |
|      |   |   |  | 1.00 < Φ   | 3                               |          |  |  |
|      |   |   |  | Total Q TY   | <b>ა</b>                        |          |  |  |

| O5 Scratches Follow NO.3 LCD black spots, white spots, contamination  Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length |   | 05 Scratches Follow NO.3 LCD black spots, white spots, contamination  | 05 Scratches Follow NO.3 LCD black spots, white spots, contamination   |
|--|---|---|--|
| Symbols Define: x: Chip length y: Chip width z: Chip thickness   |   |   |  |
| L: Electrode pad length:   | x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length  | x: Chip length y: Chip width z: Chip thickness  | x: Chip length y: Chip width z: Chip thickness   |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$   | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels: $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$  | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:  |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$   | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels: $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels: $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ |
| 6.1.1 Chip on panel surface and crack between panels:  | 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    Z Chip thickness   y: Chip width   x: Chip length     Z ≤ 1/2t   Not over viewing   x≤ 1/8a     area   2.5 | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:     Z Chip thickness                                    | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:     Z: Chip thickness                                  |
| 2. Chip thickness y. Chip width x. Chip length   | 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    Z Chip thickness   y: Chip width   x: Chip length   y < 1/8a   | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:     Z Chip thickness                                    | L: Electrode pad length:  6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:   z: Chip thickness                                    |
| i i  | 6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :   |
| i i  | 6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :   |
| · · · · · · · · · · · · · · · · · · ·  | 6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :   |
| · · · · · · · · · · · · · · · · · · ·  | 6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :  | L: Electrode pad length:  6.1 General glass chip :   |
| C. 1. Compared where abits :   |   | L: Electrode pad length:  | L: Electrode pad length:   |

| NO | Item                  | Criterion  | AQL   |
|----|-----------------------|--|---|
| 07 | Cracked<br>glass      | The LCD with extensive crack is not acceptable.  | 2.5   |
| 08 | Backlight<br>elements | 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.  | 0.65<br>2.5<br>0.65   |
| 09 | Bezel                 | 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.   | 2.5<br>0.65   |
| 10 | PCB · COB             | <ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul> | 2.5<br>2.5<br>0.65<br>2.5<br>2.6<br>0.65<br>2.5<br>2.5<br>2.5 |
| 11 | Soldering             | <ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icide.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>  | 2.5<br>2.5<br>2.5<br>0.65                                     |

| NO | Item                 | Criterion  | AQL   |
|----|----------------------|--|---|
| 12 | General<br>appearanœ | <ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 LCD pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> </ul> | 2.5<br>0.65<br>2.5<br>2.5<br>2.5<br>2.5<br>0.65<br>0.65<br>0.65 |

## DISPLAYS

## **Precautions in use of LCD Modules**

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8). T aaæ have the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9). T aaæ Ánave the right to change the PCB Rev.

## **Material List of Components for RoHs**

1. T aæ ÁÔ[ { ] [ } ^} o Ltd. hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

| Material   | (Cd)       | (Pb)        | (Hg)        | (Cr6+)      | PBBs        | PBDEs       |
|--|------------|-------------|-------------|-------------|-------------|-------------|
| Limited<br>Value                                 | 100<br>ppm | 1000<br>ppm | 1000<br>ppm | 1000<br>ppm | 1000<br>ppm | 1000<br>ppm |
| Above limited value is set up according to RoHS. |            |             |             |             |             |             |

- 2. Process for RoHS requirement:
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp.:

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max. ☐ ☐ ☐

(3) Temp. curve of reflow, max. Temp. :  $235\pm5^{\circ}$ C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

### Recommendable storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module